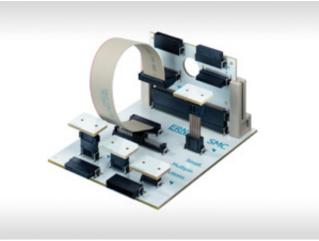


SMC

1.27 mm Connectors







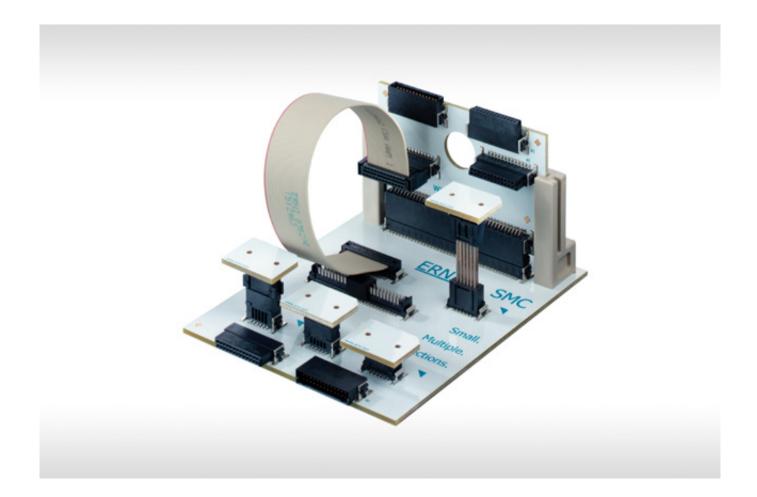
SMC - SMALL GRID, BIG POSSIBILITIES

Limited space and high performance demands are characteristics of many modern electronic systems, all of which the connectors must accommodate. There is a corresponding demand for compact, secure, and reliable connectors, with high signal integrity and a relatively high current-carrying capacity.

The comprehensive SMC range helps meet these requirements. The high-performance SMT connectors come in a number of different designs, heights, and contact densities in a 1.27 mm grid.

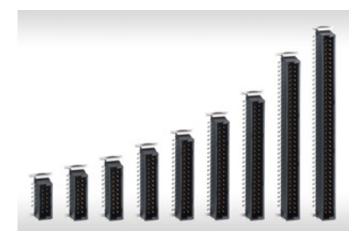
The basic design criteria for the SMC series include double-sided spring contacts for toprate contact properties and maximum contact reliability, a high-temperature resistant insulator with polarization and insertion chamfers, and a very high mating reliability.

The contact design exhibits a virtually continuous impedance profile and enables secure data transmission rates of up to 3 Gbit/s (differential) if the system is suitably designed.



FEATURES

Pitch	1.27 mm		
No. of Pins	12, 16, 20, 26, 32, 40, 50, 68, 80		
Termination technology	SMT, individual variants in pressfit technology		
	Data rate up to 3 Gbit/s		
	Current rating up to 1.7 A per contact		
	Board-to-Board connections:		
	- stacked (Mezzanine)		
Applications	- orthogonal		
	- coplanar		
	Wire-to-Board connections (ribbon cable):		
	- pluggable		
	- permanent		
	Male connectors, vertical and right angle		
	Female connectors, vertical and right angle		
Moderate	Board-to-Board adapter		
Variants	Board-on IDC		
	Cable assembly:		
	- Female connectors IDC, right angle		
	Lockable connectors		
	Pressfit male connectors		
Special versions	Reduced locating pegs / without pegs		
	First mate/early break contacts		





CAPABILITIES



Stacked boards (Mezzanine)



Board-to-Board adapter: enhanced board-to-Board heights



Extender card (coplanar)



Orthogonal boards



Wire-to-Board (pluggable)



Wire-to-Board (permanent): Board-on IDC

ADVANTAGES

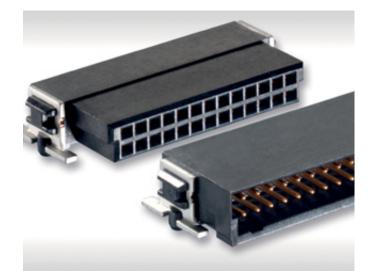
High Reliable Contact Design

- reliable, dual-beam female contact
- twisted contact tulip (90°)
- rolled, homogeneous surface, provides for more secure contact mating
- wide contact surfaces between the mated pairs
- extremely low surface roughness significantly reduces abrasion
- · low contact resistance



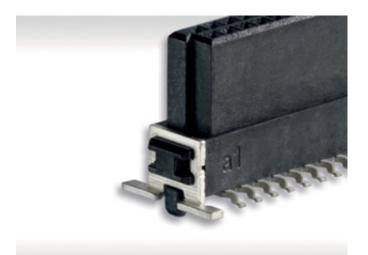
Polarization / Mating Face

- mating face polarization guards against mismating and incorrect connection
- more secure mating due to insertion chamfers in the capture range
- · distinctive guide elements for precise insertion



Robust Solder Clips

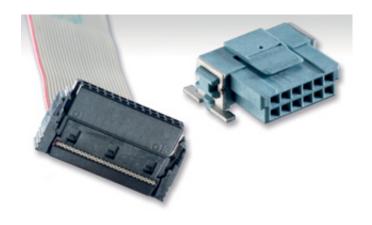
- outstanding retention forces on the circuit board
- soldering brackets absorb mechanical stress and are able to withstand high shock and vibration loads
- documented shear and tear-off forces build trust in surface-mounted connectors (e.g., shear force: min. 1000 N; tear-off force: min. 100 N)



ADVANTAGES

Interlocking Snap-In

- lockable printed circuit board (PCB) and cable connectors
- secured against heavy vibration and shock loads
- snap-in: locking when mating; can only be released with tools
- cable connector: integrated locking lever; can be manually released without tools
- protection against accidental release of Wire-to-Board connections
- cable guide provides for strain relief



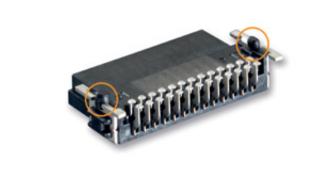
Snap-In B-to-B Adapter

- single-sided locking of Board-to-Board adapters on low-profile female connectors
- enables the mating and release of two boards always on one specified side



Locating Pegs

- geometrically heterogeneous locating pegs for precise positioning on the circuit board
- enables excellent compensation of PCB holes for both positive and negative tolerances



PROCESSING

Tape and Reel Packaging

- transport safe packaging
- automatic assembly



Automatic Assembly and Reflow Soldering

• for efficient processing on modern assembly lines



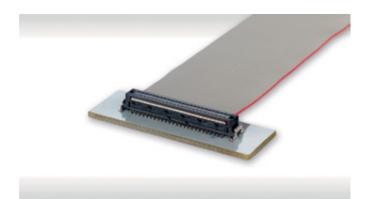
Backside Reflow Soldering

• capable of two sided reflow soldering



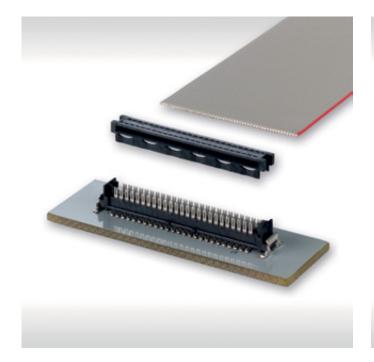
Permanent Wire-to-Board Connection (Board-on IDC)

• automated and cost-efficient assembly of ribbon cables

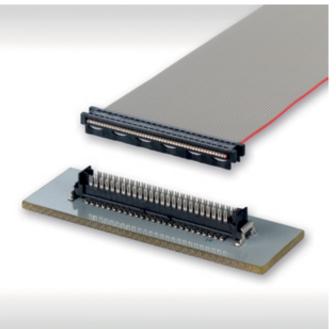


BOARD-ON IDC

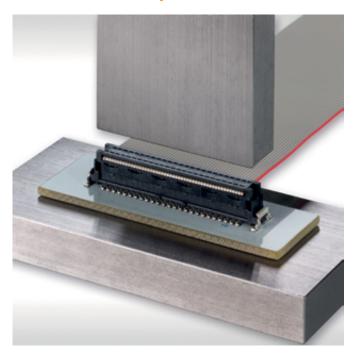
Automated Assembly



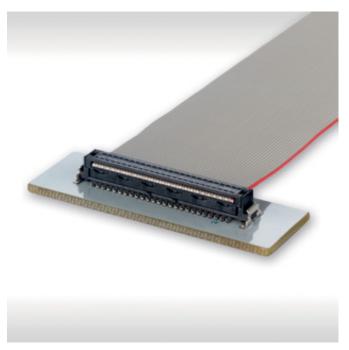
Feeding of the Ribbon Cable and Cable Guide



Press-in without Special Tool

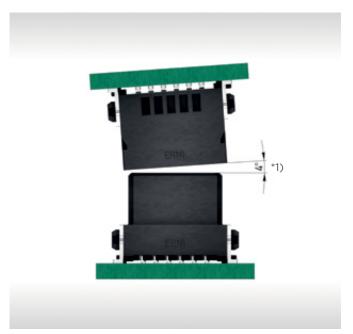


Processed Connection



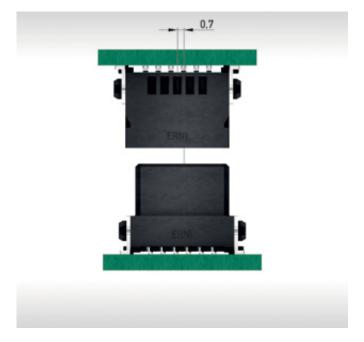
MATING CONDITIONS

Allowed Inclination for a more Secure Self-Centering





Allowed Misalignment Tolerances for a more Secure Self-Centering





^{*1)} depends on no. of pins and misalignment tolerance

BOARD-TO-BOARD HEIGHT

Stacked Boards / Mezzanine



Board-to-Board Height	Male Stacking Height	Female Stacking Height
8.00 - 9.50 mm	1.75 mm	6.25 mm
9.50 - 11.00 mm	3.25 mm	6.25 mm
10.80 - 12.30 mm	1.75 mm	9.05 mm
12.30 - 13.80 mm	3.25 mm	9.05 mm
13.90 - 15.40 mm	4.85 mm	9.05 mm
15.40 - 16.90 mm	1.75 mm	13.65 mm
16.90 - 18.40 mm	3.25 mm	13.65 mm
18.50 - 20.00 mm	4.85 mm	13.65 mm



Board-to-Board Height	Board-to-Board Adapter	Female Stacking Height
20 mm	20 mm	2 x 6.25 mm
22 mm	22 mm	2 x 6.25 mm
24 mm	24 mm	2 x 6.25 mm
26 mm	26 mm	2 x 6.25 mm
28 mm	28 mm	2 x 6.25 mm
30 mm	30 mm	2 x 6.25 mm
32 mm	32 mm	2 x 6.25 mm
34 mm	34 mm	2 x 6.25 mm
36 mm	36 mm	2 x 6.25 mm
38 mm	38 mm	2 x 6.25 mm
40 mm	38 mm (wipe length)	2 x 6.25 mm

ELECTRICAL AND MECHANICAL CHARACTERISTICS

Technical Data

Climate category DIN EN 60068-1 test b 55 / 150 / 56 55 / 125 / 56 -55 / 125 °C (TPE-S Cable) -55 / 125 °C (TPE-S Cable	Description	Standard	PCB Connectors, Cable Board-on IDC (Ribbon Cable AW Assemblies, B-to-B Adapter 30, 250 mm)		
Temperature range	Climate category	DIN EN 60068-1 test b	55 / 150 / 56	55 / 125 / 56	
-55/125 °C (TPE-S Cable) 12-pin version at 20 °C ambient temperature: 1.7 A (up to 2.7 A with optimized layout) 1.7 A (up to 2.7 A (up to 2.7 A) 1.7 A (up to 2.7 A) 1.7 A (up to 2.7 A)			-55 / 125 °C (PCB Connectors)	_	
Current rating per contact EC60512 test 5b 1.7 A (up to 2.7 A with optimized layout)	Temperature range		-55 / 125 °C (TPE-S Cable)	-55 / 125 °C (TPE-S Cable)	
Air- and creepage distance Contact - contact min. 0.4 mm The permissible operating voltages depend on the customer application and on the applicable or specified safety requirements, insulation coordination according to IEC 60664+1 has to be regarded for the complete electrical device. Therefore, the maximum creepage and clearance distances of the mated connectors are specified for consideration as a part of the whole current path. In practice, reducins in creepage or clear-ance distances may occur due to the conductive pattern of the printed board or the wiring used, and have to be taken into account separately. As a result the creepage and clearance distances for the application may be reduced compared to those of the connector. Dielectric strength IEC 60512 test 4a Contact resistance IEC 60512 test 2a Contact resistance IEC 60512 test 3a > 10 mΩ (cable assemblies) Insulation resistance IEC 60512 test 3a > 10 mΩ (cable assemblies) Insulation resistance IEC 60512 test 6d 10 - 2000 Hz 20 g Contact disturbance (while vibration test) IEC 60512 test 2e (while vibration test) IEC 60512 test 2e (while vibration test) IEC 60512 test 2e (while shock test) IEC 60512 test 2e (shock and shodering temperature max. IEC 6068-2-20 Insertion and withdrawal force max. IEC 6068-2-20 Insertion and withdrawal force max. IEC 60068-2-20 IEC 60068-2-20 Insertion and withdrawal force max. IEC 60068-2-20 IEC 60068-2-2	Current vating new central			C ambient temperature:	
The permissible operating voltages depend on the customer application and on the applicable or specified safety requirements. Insulation coordination according to IEC 606641 has to be regarded for the complete electrical device. Therefore, the maximum creepage and clearance distances of the mated connectors are specified for consideration as a part of the whole current path. In practice, reductions in creepage or clearance distances may occur due to the conductive pattern of the printed board or the wiring used, and have to be taken into account separately. As a result the creepage and clearance distances for the application may be reduced compared to those of the connector. Dielectric strength IEC 60512 test 4a contact - contact 500 V _{ma} < 35 mΩ (Board-to-Board Height 18.50 - 20.00 mm) < 10 mΩ (cable assemblies) Insulation resistance IEC 60512 test 3a 10 - 2000 Hz 20 g Contact disturbance (while vibration test) IEC 60512 test 6d 20 g Contact disturbance (while vibration test) IEC 60512 test 2e 10 mΩ (cable assemblies) IEC 60512 test 2e 11 ms Contact disturbance (while shock test) IEC 60512 test 2e 10 msertion and withdrawal force max. Gauge retention force IEC 60512 test 3b 0.5 N per contact Processing Conditions Hand soldering temperature max. JEC 60068-2-20 10 s at 260 °C Reflow soldering JEDEC 20 - 40 s at 260 °C		IEC60512 test 5b	1.7 A (up to 2.7 A with optimized layout)		
and on the applicable or specified safety requirements. Insulation coordination according to IEC 60664-1 has to be regarded for the complete electrical device. Therefore, the maximum energage and clearance distances of the material department of the whole current path. In practice, reductions in creepage or clearance distances may occur due to the conditive pattern of the printed board or the wiring used, and have to be taken into account separately. As a result the creepage and clearance distances for the application may be reduced compared to those of the connector. Dielectric strength IEC 60512 test 4a contact - contact 500 V _{rms} Contact resistance IEC 60512 test 2a < 35 mΩ (Board-to-Board Height 18.50 - 20.00 mm)	Air- and creepage distance		contact - cont	act min. 0.4 mm	
Contact resistance IEC 60512 test 2a (35 mΩ (Board-to-Board Height 18.50 - 20.00 mm) (10 mΩ (cable assemblies) (10 mΩ (cable assemb	Operating voltage	IEC 60664	and on the applicable or specified safety requirements. Insulation coordination according to IEC 60664-1 has to be regarded for the complete electrical device. Therefore, the maximum creepage and clearance distances of the mated connectors are specified for consideration as a par of the whole current path. In practice, reductions in creepage or clearance distances may occur due to the conductive pattern of the printed board or the wiring used, and have to be taken into account separately. As a result the creepage and clearance distances for the application materials.		
Contact resistance IEC 60512 test 2a	Dielectric strength	IEC 60512 test 4a	contact - co	ntact 500 V _{rms}	
Vibration, sine IEC 60512 test 6d Contact disturbance (while vibration test) Shock halfsine IEC 60512 test 2e Shock halfsine IEC 60512 test 6c IEC 60512 test 6c IEC 60512 test 2e Shock halfsine IEC 60512 test 2e IEC 60512 test 2e IEC 60512 test 2e Shock halfsine Shock halfsine Shock halfsine IEC 60512 test 2e Shock halfsine	Contact resistance	IEC 60512 test 2a	< 35 m Ω (Board-to-Board Height 18.50 - 20.00 mm)	< 10 mΩ	
Vibration, sine IEC 60512 test 6d 20 g Contact disturbance (while vibration test) Shock halfsine IEC 60512 test 6c 50 g 11 ms Contact disturbance (while shock test) Mechanical operation IEC 60512 test 9a 500 mating cycles Insertion and withdrawal force max. Gauge retention force IEC 60512 test 16e > 0.1 N Processing Conditions Hand soldering temperature max. Dip soldering temperature max. Reflow soldering JEDEC J-STD-020 IEC 60512 test 6c 11 ms 50 g 11 ms 50 g 11 ms 50 g 11 ms 500 mating cycles 10 s at 260 °C 20 - 40 s at 260 °C	Insulation resistance	IEC 60512 test 3a	> 10 ⁴ MΩ		
Contact disturbance (while vibration test) Shock halfsine IEC 60512 test 2e Shock halfsine IEC 60512 test 6c IEC 60512 test 6c IEC 60512 test 2e Shock halfsine Shock hal	Vibration, sine	IEC 60512 test 6d			
Shock halfsine IEC 60512 test 6c 11 ms Contact disturbance (while shock test) IEC 60512 test 2e		IEC 60512 test 2e	<	1 μs	
(while shock test)IEC 60512 test 2e< 1 μsMechanical operationIEC 60512 test 9a500 mating cyclesInsertion and withdrawal force max.IEC 60512 test 13b0.5 N per contactGauge retention forceIEC 60512 test 16e> 0.1 NProcessing ConditionsHand soldering temperature max.IEC 60068-2-203.5 s at 350 °CDip soldering temperature max.IEC 60068-2-2010 s at 260 °CReflow soldering temperature max.JEDEC J-STD-02020 - 40 s at 260 °C	Shock halfsine	IEC 60512 test 6c			
Insertion and withdrawal force max. Gauge retention force IEC 60512 test 16e > 0.5 N per contact Processing Conditions Hand soldering temperature max. Dip soldering temperature max. IEC 60068-2-20		IEC 60512 test 2e	<	1 μs	
force max. Gauge retention force IEC 60512 test 13b O.5 N per contact > 0.1 N Processing Conditions Hand soldering temperature max. Dip soldering temperature max. IEC 60068-2-20	Mechanical operation	IEC 60512 test 9a	500 mat	ing cycles	
Processing Conditions Hand soldering temperature max. Dip soldering temperature max. EC 60068-2-20 IEC 600	_	IEC 60512 test 13b	0.5 N pe	er contact	
Hand soldering temperature max. Dip soldering temperature max. IEC 60068-2-20 IEC 60068-2-2	Gauge retention force	IEC 60512 test 16e	> (0.1 N	
max. Dip soldering temperature max. IEC 60068-2-20 10 s at 260 °C Max. IEC 60068-2-20 10 s at 260 °C Reflow soldering temperature max. JEDEC 20 - 40 s at 260 °C	Processing Conditions				
max. Reflow soldering temperature max. IEC 60068-2-20 JEDEC 20 - 40 s at 260 °C 20 - 40 s at 260 °C		IEC 60068-2-20	3.5 s at 350 °C		
temperature max. J-STD-020 20 - 40 s at 260 °C		IEC 60068-2-20	10 s at 260 °C		
			20 - 40 s at 260 °C		
· Oil IIIII	Coplanarity		< 0.1 mm		

ELECTRICAL AND MECHANICAL CHARACTERISTICS

Technical Data

Description	Standard	PCB Connectors, Cable Assemblies, B-to-B Adapter	Board-on IDC (Ribbon Cable AWG 30, 250 mm)
Housing Material	Jundara	Assembles, 5 to 5 Adapter	(Kibboli Gubic Avvo 30, 230 hill)
Insulation body			LCP
CTI value	IEC 112		175
UL flame rating		- 1	UL 94 V-0
UL file plastic material			E83005
Contact Material		,	
Base material			Cu alloy
Mating area		gold plating	-
Termination area			Sn
Environment Compatibi	lity		
Recycling		no flame-retardant additives,	no toxic additives allow easy recycling
Product Approval	,		
UL/CSA			E84703

Partial LV214 testing for selected SMC configurations done. If you want to know more, please contact TE/ERNI. In general, testings are done according to connector standards. No liability for usage of connectors in the application.

ELECTRICAL AND MECHANICAL CABLE CHARACTERISTICS

Technical Data Flat Ribbon Cables

Description	Standard cable (PVC)	High Temperature Cable (TPE-S)	Halogen-free Cable (Polyolefin TPE-O)	
Cross section	AWG-30/ 7/ 0.06 mm ²			
Conductor	stranded Cu wire, tinned, 7x0.102 / 0.06 mm ²			
Coded wire	available			
Insulation	PVC gray (similar to RAL 78032)	TPE-S gray (similar to RAL 78032)	TPE-O gray (similar to RAL 78032)	
Insulation thickness		min. 0.1mm		
Shore hardness	94 ±2 (Shore A)	52 ±3 (Shore D)	94 ±2 (Shore A) resp.	
	0 (00.0 / 1)	02 20 (0.10.0 2)	50 ±3 (Shore D)	
Technical Data				
T	-20/105 °C (fixed)	-60/125 °C (fixed)	-40/105 °C (fixed)	
Temperature range	-10/105 °C (mobile)	-40/125 °C (mobile)	-20/105 °C (mobile)	
Dielectric strength	1500 V _{rms}	1000 V _{rms}	1200 V _{rms}	
Conductor resistance		\leq 350 Ω /km at 20 °C		
Insulation resistance		\geq 20 M Ω x km at 20 °C		
Inama dan aa	125 Ω (wire-wire)	176 O (wine wine)	110 Ω (wire-wire)	
Impedance	80 Ω (Ground-Signal-Ground)	136 Ω (wire-wire)	75 Ω (Ground-Signal-Ground)	
Bending cycles (typical)		min. 1 million at 20 x cable diam	eter	
RoHS	compliant			
Flame rating	UL 94 VW-1	IEC 60332-1-2	UL 1581 (Horizontal Flame Test)	



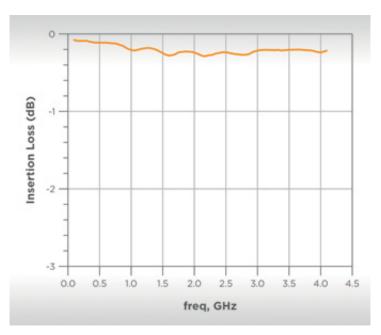
HIGH FREQUENCY CHARACTERISTICS

High-Speed Data Transmission

SMC connectors as solution for unshielded high-speed applications. The practically continuous impedance profile allows for more secure data transmission rates of up to 3 Gbit/s (differential) if the system is suitably designed.

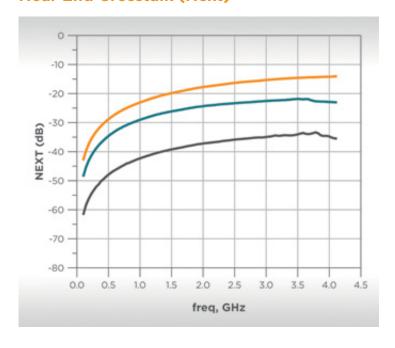
- de-embedded measurement results for the micro backplane/daughter card application
- 50-pin SMC, angled female connector, straight male connector (low profile)
- · differential signal transmission

Insertion Loss





Near End Crosstalk (Next)





 Agressor / Victim
 A2_3 / B2_3
A2_3 / A4_5
A2_3 / B4_5 (shown above)

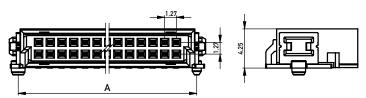
RIGHT ANGLE MALE

Product Specification

- Surface mount technology (SMT) termination
- dual row connector
- data rates up to 3 Gbit/s
- location pegs for exact board placement
- black insulation body for fast and reliable visual recognition
- automated board assembly
- for available part numbers please refer to our website

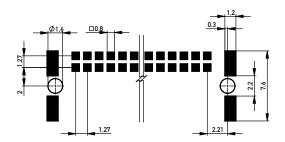


Dimensional Drawings



PPPPPPPPPPPP T	
	•
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Recommended Layout



No. of Contacts	Α	В	С
12	10.77	12.70	10.35
16	13.31	15.24	12.91
20	15.85	17.78	15.45
26	19.66	21.59	19.26
32	23.47	25.40	23.07
40	28.55	30.48	28.15
50	34.90	36.83	34.50
68	46.33	48.26	45.93
80	53.95	55.88	53.55

All dimensions in mm.

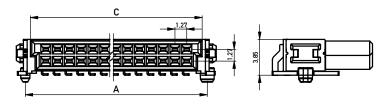
RIGHT ANGLE FEMALE

Product Specification

- SMT termination
- dual row connector
- data rates up to 3 Gbit/s
- location pegs for exact board placement
- black insulation body for fast and reliable visual recognition
- automated board assembly
- for available part numbers please refer to our website

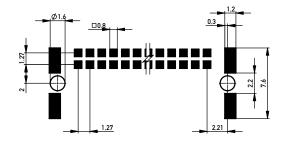


Dimensional Drawings



-		В	-	
	рррррр	ррррррр		
				10.8

Recommended Layout



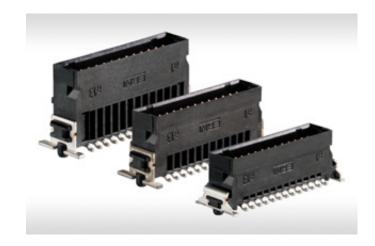
No. of Contacts	Α	В	С
12	10.77	12.70	9.37
16	13.31	15.24	11.91
20	15.85	17.78	14.45
26	19.66	21.59	18.26
32	23.47	25.40	22.07
40	28.55	30.48	27.15
50	34.90	36.83	33.50
68	46.33	48.26	44.93
80	53.95	55.88	52.55

All dimensions in mm.

VERTICAL MALE

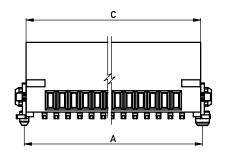
Product Specification

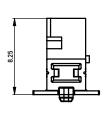
- SMT termination
- dual row connector
- data rates up to 3 Gbit/s
- location pegs for exact board placement
- black insulation body for fast and reliable visual recognition
- automated board assembly
- 3 stacking heights (1.75, 3.25, 4.85 mm)
- for available part numbers please refer to our website

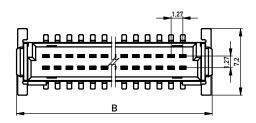


Dimensional Drawings

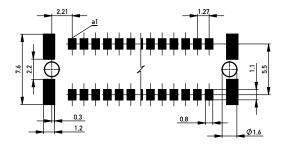
Unmated Stacking Height 3.25 mm







Recommended Layout



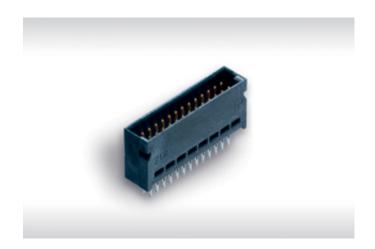
No. of Contacts	Α	В	С
12	10.77	12.70	10.37
16	13.31	15.24	12.91
20	15.85	17.78	15.45
26	19.66	21.59	19.26
32	23.47	25.40	23.07
40	28.55	30.48	28.15
50	34.90	36.83	34.50
68	46.33	48.26	45.93
80	53.95	55.88	53.55

All dimensions in mm.

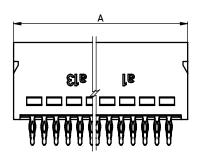
VERTICAL MALE PRESSFIT

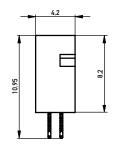
Product Specification

- pressfit termination
- dual row connector
- data rates up to 3 Gbit/s
- black insulation body for fast and reliable visual recognition
- virtually automated board assembly
- stacking height 3.25 mm
- press-in tools and toggle presses available from ERNI
- for available part numbers please refer to our website



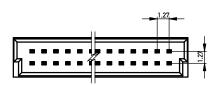
Dimensional Drawings



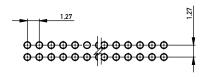


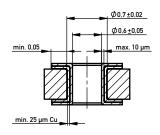
No. of	
Contacts	Α
12	10.35
26	19.24
50	34.48
68	45.91
80	53.53

All dimensions in mm.



Recommended Layout | Hole Design

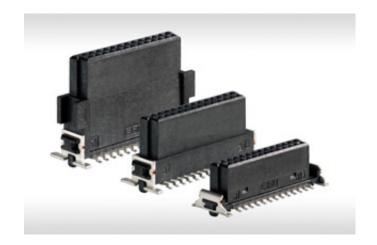




VERTICAL FEMALE

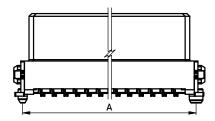
Product Specification

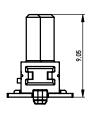
- SMT termination
- dual row connector
- data rates up to 3 Gbit/s
- location pegs for exact board placement
- black insulation body for fast and reliable visual recognition
- automated board assembly
- 3 stacking heights (6.25, 9.05, 13.65 mm)
- for available part numbers please refer to our website

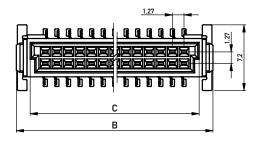


Dimensional Drawings

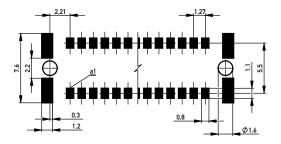
Unmated Stacking Height 9.05 mm







Recommended Layout



No. of Contacts	Α	В	С
12	10.77	12.70	9.37
16	13.31	15.24	11.91
20	15.85	17.78	14.45
26	19.66	21.60	18.26
32	23.47	25.40	22.07
40	28.55	30.48	27.15
50	34.90	36.80	33.50
68	46.33	48.20	44.93
80	53.95	55.80	52.55

All dimensions in mm.

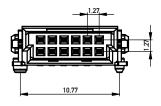
RIGHT ANGLE MALE WITH LOCKING SYSTEM

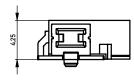
Product Specification

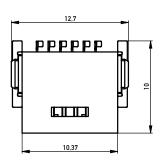
- two types of interlocking:
 - positive lock (blue colored): unlockable i.e. by tool, tip of pen
 - friction lock (black colored): unlockable without any tool
- SMT termination
- data rates up to 3 Gbit/s
- location pegs for exact board placement
- automated board assembly
- for available part numbers please refer to our website



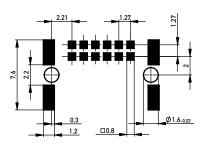
Dimensional Drawings







Recommended Layout



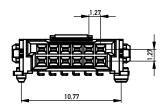
RIGHT ANGLE FEMALE WITH LOCKING SYSTEM

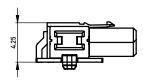
Product Specification

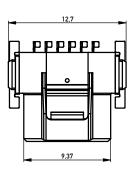
- two types of interlocking:
 - positive lock (blue colored): unlockable
 i.e. by tool, tip of pen
 - friction lock (black colored): unlockable without any tool
- SMT termination
- data rates up to 3 Gbit/s
- location pegs for exact board placement
- automated board assembly
- for available part numbers please refer to our website



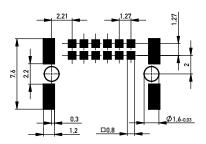
Dimensional Drawings







Recommended Layout



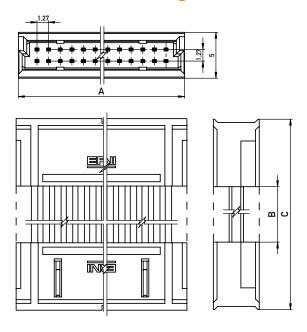
BOARD-TO-BOARD ADAPTER

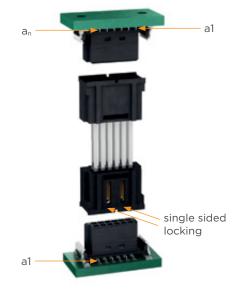
Product Specification

- Board-to-Board adapter for parallel PCB distances of 20-40 mm
- moulded (hotmelt) versions for improved environmental resistance and finger safe protection
- single-sided locking of Board-to-Board adapters on low-profile female connectors
- enables the mating and release of two boards always on one specified side
- for available part numbers please refer to our website



Dimensional Drawings





No. of	
Contacts	Α
12	10.37
26	19.26
50	34.50
68	45.93
80	53.55

All dimensions in mm.

B-to-B Adapter

B-10-B Adapter		
(Board-Distance)	В	С
20	3.5	18.2
22	5.5	20.2
24	7.5	22.2
26	9.5	24.2
28	11.5	26.2
30	13.5	28.2
32	15.5	30.2
34	17.5	32.2
36	19.5	34.2
38	21.5	36.2

BOARD-ON IDC

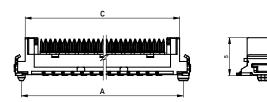
Product Specification

- permanent wire-to-board connection
- SMT and IDC termination
- · dual row connector
- data rates up to 3 Gbit/s
- · location pegs for exact board placement
- black insulation body for fast and reliable visual recognition
- flat ribbon cables AWG 30
- easy assembly with standard toggle press
- for available part numbers please refer to our website



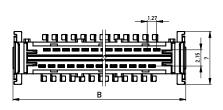
Dimensional Drawings | Recommended Layout

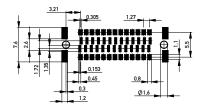
Board-on Connectors



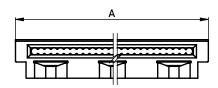
No. of Contacts	Α	В	С
12	12.77	14.70	11.78
26	21.66	23.59	20.67
50	36.90	38.83	35.91

All dimensions in mm.





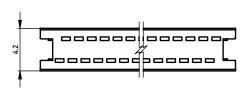
Board-on Cable Guide





No. of Contacts	Α	В
12	10.78	6.98
26	19.67	15.87
50	34.91	31.11

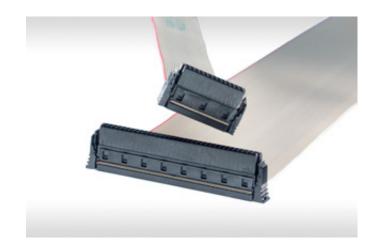
All dimensions in mm.

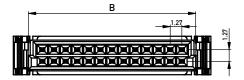


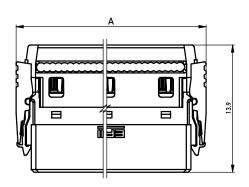
Product Specification

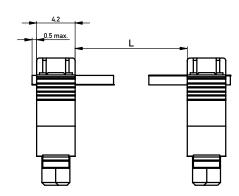
- cable assemblies with IDC female connectors
- ribbon cable AWG 30/7
- three different cable types
- for available part numbers please refer to our website

Dimensional Drawings









No. of Contacts	Α	В
12	12.69	9.37
16	15.23	11.91
20	17.77	14.45
26	21.58	18.26
32	25.39	22.07
40	32.53	27.15
50	38.88	33.50
68	50.31	44.93
80	57.93	52.55

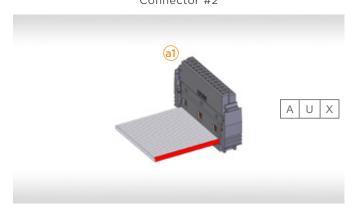
All dimensions in mm.

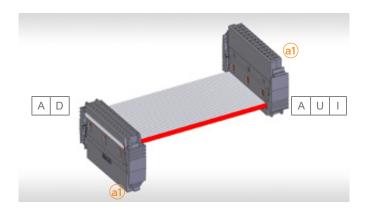
Standard

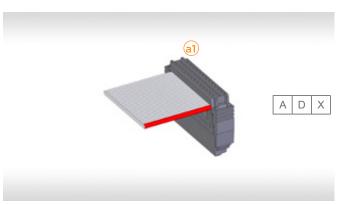
Configurations

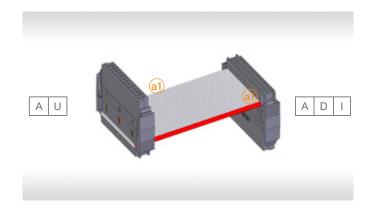
Connector #2 Connector #1

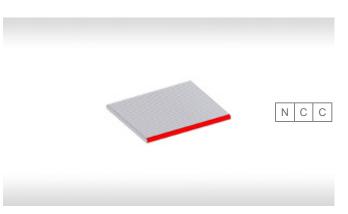
Crossed Connector #2











Cable Types



Standard

- standard ribbon cable with PVC insulation
- AWG 30/7
- excellent abrasion and cut resistance
- temperature range: -10 °C to +105 °C
- UL2678

High Temperature

- high temperature resistant ribbon cable with TPE-S insulation
- AWG 30/7
- excellent abrasion and cut resistance
- temperature range: -40 °C to +125 °C

Halogen-free

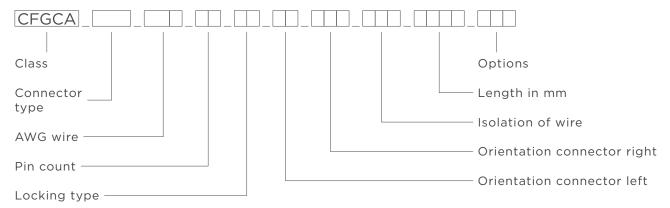
- halogen-free ribbon cable with TPE-O insulation
- AWG 30/7
- excellent abrasion and cut resistance
- oil-resistant (ASTM 2)
- temperature range: -20 °C to +105 °C
- UL22092







Ordering Information Standard Cable Assemblies



Example for a standard configuration:

CFGCA SMC 30R 112 LL AU AUI PVC 01175 ANN

Ordering code field	Number of digits	Example configuration	Composition of the conf	iguration
Class	5	CFGCA	ConFiGurable Cable Assembly	
Connector type	3	SMC	SMC	
ANA/Cin-	7	700	1st and 2nd column:	30
AWG wire	3	30R	3rd column:	Ribbon Cable
Pin count	2	12	12, 16, 20, 26, 32, 40, 50, 68, 80	
Looking type	2		Locking Latches	
Locking type	2	LL	Secure Lock	
Orientation connector left	2	AU	Angeled Up	
Orientation connector left	2	AU	Angeled Down	
		AUI	1st and 2nd column:	Angeled U p
				Angeled Down
Orientation connector right	3			Not ConneCted
			3rd column:	I-connected (1:1)
				X-connected (1:N)
			PVC : -10 °C to +105 °C	
Isolation of wire	2 - 4	PVC	TPE : -40 °C to +125 °C	
			PO: -20 °C to +105 °C, halogen free	
Length in mm	4	0175	175 mm / 25 - 2500 mm possible	
Options	3	ANN	1st column:	Asymmetric
				S ymmetric
			2nd and 3rd column:	custom PRint
				UL Label
				Print ad U L Label
				No print No UL label

Product Specific Technical Notes

- intended use: the offered products, i.e. cable assemblies, are components used in devices for internal wiring in non-critical industrial applications
- not intended to be used in live-support applications, no safety-classified applications, not intended for automotive use, not intended for applications with danger to life and limb
- desired audience: (professional) company customers who assume the full responsibilty for their products including the ERNI cable assembly product under consideration
- customer has to carefully check the product's appropriateness for the desired use (application) with the help of its technical specifications and additionally verify that the operation of the product in said application is in agreement with all requirements that may be applicable under the scope of the actual application (applicable regulation, law, and whatever more)
- product solely ERNI-internally sampled and released customer FAI report will not be provided (also includes PPaPs, CofCs, acceptance test certificates and IMDS Data)
- ERNI may change suppliers or mix materials from various sources as long as the specification layed out here will be maintained (assumption of fit-form-function)
- · outside these product offerings customer-specific assemblies to be inquired separately

Connect With Us

We make it easy to connect with our experts and are ready to provide the support you need. Visit www.te.com/support to chat with a Product Information Specialist.

te.com

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JS 10/23 Original

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